



CBR-SMD RF COG, Ceramic, 24 pF, 2%, 250 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



CBR-SMD RF COG
SMD Chip
SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Ultra High Q, Low ESR, Class I
Yes
Tin
No
No
12.03 mg
Solder Wave or Solder Reflow.
78 Weeks
1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.85mm +/-0.1mm
В	0.5mm +/-0.2mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

Specifications	
Capacitance	24 pF
Tolerance	2%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.114%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	880

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